

STTH200W06TV1

Turbo 2 ultrafast high voltage rectifier

Datasheet - production data

Features

- Ultrafast switching
- Low reverse recovery current
- Low thermal resistance
- Reduces switching and conduction losses
- Insulated package
 - Insulating voltage = 2500 V rms
 - Capacitance = 45 pF
- Complies with UL standards (File ref: E81734)

Description

The STTH200W06TV1, which uses ST Turbo 2, 600 V technology, is especially suited to be used for DC/AC and DC/AC converters in primary stage of MIG/MMA/TIG welding machine.

Packaged in ISOTOP, this device offers high power integration for all welding machines and industrial equipment.

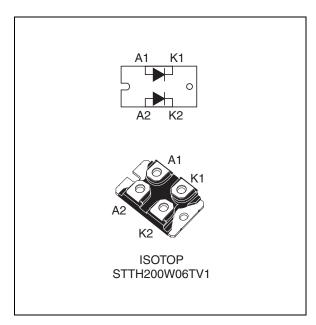


Table 1. Device summary

Symbol	Value			
I _{F(AV)}	2 x 100 A			
V_{RRM}	600 V			
T _j (max)	150 °C			
V _F (typ)	1.0 V			
t _{rr} (typ)	55 ns			

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1 Characteristics

Table 2. Absolute ratings (limiting values at $T_i = 25$ °C, unless otherwise specified, per diode)

	<u> </u>			
Symbol	Parameter		Value	Unit
V_{RRM}	Repetitive peak reverse voltage		600	V
I _{F(RMS)}	Forward rms current	Per diode	145	Α
I _{F(peak)}	Average forward current, $\delta = 0.2$	Per diode T _c = 105 °C	200	Α
I _{FSM}	Surge non repetitive forward current t _p = 10 ms Sinusoidal		800	Α
T _{stg}	Storage temperature range			°C
T _j	Maximum operating junction temperature		150	°C

Table 3. Thermal parameters

Symbol	Parameter		Value	Unit
В	lungtion to good	Per diode	0.7	
R _{th(j-c)}	Junction to case	Total	0.4	°C/W
R _{th(c)}	Coupling		0.1	

When the two diodes 1 and 2 are used simultaneously:

 $\Delta T_{j}(diode\ 1) = P\ (diode\ 1)\ X\ R_{th(j\text{-}c)}\ (per\ diode) + P\ (diode\ 2)\ x\ R_{th(c)}$

Table 4. Static electrical characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _R ⁽¹⁾	T _j = 25 °C		-		30		
'R`	I _R ⁽¹⁾ Reverse leakage current	T _j = 125 °C	$V_R = V_{RRM}$	-	30	300	μA
	$V_F^{(2)}$ Forward voltage drop $T_j = T_j = T$	T _j = 25 °C	I _F = 100 A			1.5	
V (2)		T _j = 150 °C		-	1	1.3	V
v _F , ,		T _j = 25 °C	I _F = 200 A	-		1.75	V
		T _j = 150 °C	1F = 200 A	-	1.25	1.60	

^{1.} Pulse test: t_p = 5 ms, δ < 2%

To evaluate the conduction losses use the following equation:

$$P = 1.0 \text{ x } I_{F(AV)} + 0.003 \text{ x } I_{F}^{2}_{(RMS)}$$

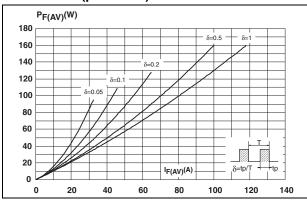
^{2.} Pulse test: t_p = 380 μ s, δ < 2%

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Table 5. Dynamic characteristics (per diode)

Symbol	Parameter	Test conditions		Min.	Тур.	Max.	Unit
I _{RM}	Reverse recovery current			-	30	40	Α
Q _{RR}	Reverse recovery charge	$T_j = 125 ^{\circ}\text{C}$ $I_F = 100 \text{A}, V_R = 400 \text{V}$ $dI_F/dt = -200 \text{A}/\mu\text{s}$			4600		nC
S _{factor}	Softness factor		d.p/at = 250 / vpc		0.4		
t _{rr}	Reverse recovery time	T _j = 25 °C	$I_F = 1 \text{ A}, V_R = 30 \text{ V}$ $dI_F/dt = -100 \text{ A/}\mu\text{s}$	-	55	75	ns
t _{fr}	Forward recovery time	$T_j = 25 ^{\circ}\text{C}$ $I_F = 100 \text{A}, V_{FR} = 2.5 \text{V}$		-		2000	ns
V _{FP}	Forward recovery voltage	T _j = 25 °C	11 / 11 400 Å /		3.3	5	V

Figure 1. Average forward power dissipation Figure 2. Forward voltage drop versus versus average forward current forward current (per diode) (per diode)



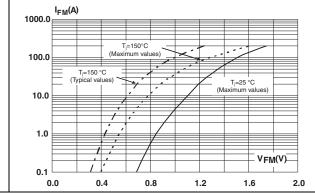
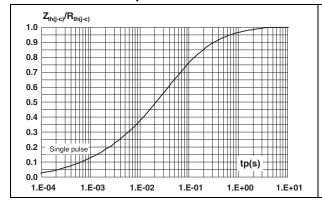
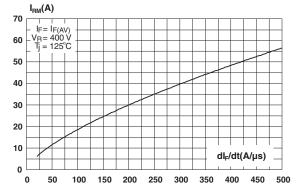


Figure 3. Relative variation of thermal impedance, junction to case, versus pulse duration

Figure 4. Peak reverse recovery current versus dl_F/dt (typical values, per diode)





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Figure 5. Reverse recovery time versus dl_F/dt Figure 6. Reverse recovery charges versus (typical values, per diode) dl_F/dt (typical values, per diode)

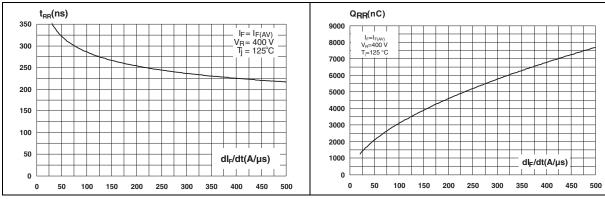


Figure 7. Reverse recovery softness factor versus dl_F/dt (typical values, per diode)

Figure 8. Relative variation of dynamic parameters versus junction temperature

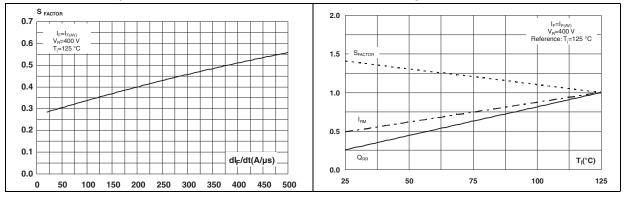
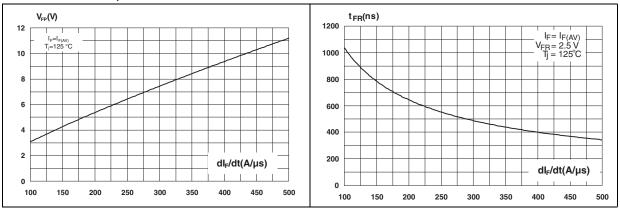


Figure 9. Transient peak forward voltage versus dl_F/dt (typical values, per diode)

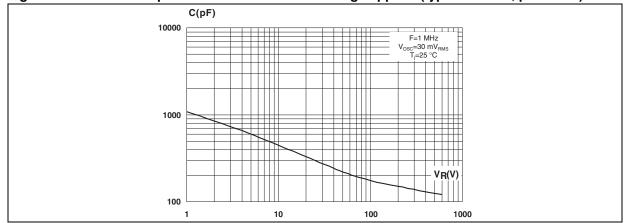
Figure 10. Forward recovery time versus dl_F/dt (typical values, per diode)



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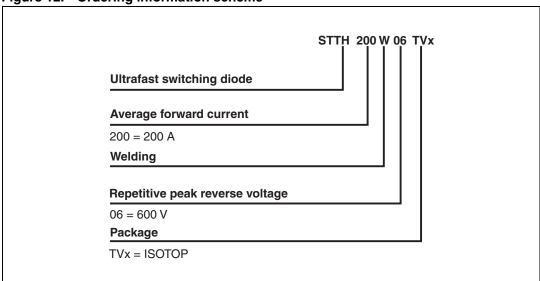
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Figure 11. Junction capacitance versus reverse voltage applied (typical values, per diode)



2 Ordering information scheme

Figure 12. Ordering information scheme

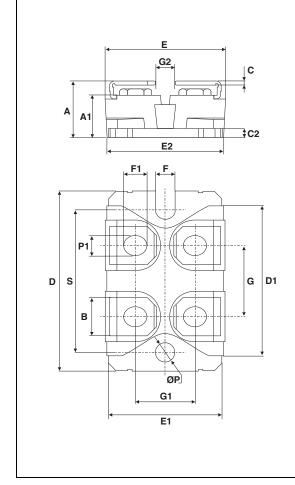


3 Package information

- Epoxy meets UL94, V0
- Cooling method: by conduction (C)
- Recommended torque value: 1.3 N⋅m (1.5 N⋅m maximum)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK[®] packages, depending on their level of environmental compliance. ECOPACK[®] specifications, grade definitions and product status are available at: *www.st.com*. ECOPACK[®] is an ST trademark.

Table 6. ISOTOP dimensions



	Dimensions				Dimensions			
Ref.	Millimeters		Millimeters		Inc	hes		
	Min.	Max.	Min.	Max.				
Α	11.80	12.20	0.465	0.480				
A1	8.90	9.10	0.350	0.358				
В	7.8	8.20	0.307	0.323				
С	0.75	0.85	0.030	0.033				
C2	1.95	2.05	0.077	0.081				
D	37.80	38.20	1.488	1.504				
D1	31.50	31.70	1.240	1.248				
Е	25.15	25.50	0.990	1.004				
E1	23.85	24.15	0.939	0.951				
E2	24.80) typ.	0.976 typ.					
G	14.90	15.10	0.587	0.594				
G1	12.60	12.80	0.496	0.504				
G2	3.50	4.30	0.138	0.169				
F	4.10	4.30	0.161	0.169				
F1	4.60	5.00	0.181	0.197				
Р	4.00	4.30	0.157	0.69				
P1	4.00	4.40	0.157	0.173				
S	30.10	30.30	1.185	1.193				

4 Ordering information

Table 7. Ordering information

Order code	Marking	Package	Weight	Base qty ⁽¹⁾	Delivery mode
STTH200W06TV1	STTH200W06TV1	ISOTOP	27 g	10 with screws	Tube

This product is supplied with 40 terminal screws and washers for each tube. The screws and washers are supplied in a separate pack with the order.

5 Revision history

Table 8. Document revision history

Date	Revision	Changes
05-Oct-2012	1	First issue

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